



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

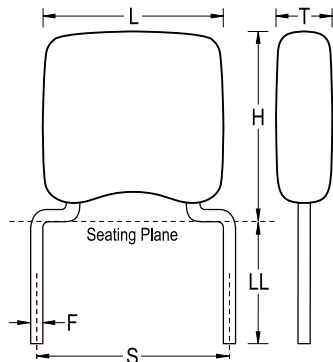
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GoldMax 300 Comm Z5U, Ceramic, 0.1 uF, 20%, 50 VDC, Z5U, GoldMax, Commercial Standard, Lead Spacing = 6.35mm



General Information	
Supplier:	KEMET
Series:	GoldMax 300 Comm Z5U
Style:	Radial
Description:	GoldMax, Commercial Standard
RoHS:	Yes
Termination:	Tin
Failure Rate:	N/A
Halogen Free:	Yes

Dimensions	
L	5.08mm MAX
H	6.6mm MAX
T	3.18mm MAX
S	6.35mm +/-0.78mm
LL	7mm MIN
F	0.51mm +0.1/-0.025mm

Specifications	
Capacitance:	0.1 uF
Capacitance Tolerance:	20%
Voltage DC:	50 VDC
Dielectric Withstanding Voltage:	125 V
Temperature Range:	-10/+85C
Temperature Coefficient:	Z5U
Dissipation Factor:	4.00% 25C
Aging Rate:	7% Loss/Decade Hour
Insulation Resistance:	1 GOhms

Packaging Specifications	
Packaging:	Bulk, Bag
Packaging Quantity:	500